

Appl. No. 10/712,708
Amdt. dated July 13, 2007
Reply to Non-Compliant Amend Notice of June 15, 2007

PATENT

made from materials with high thermal conductivity also form a multi-stage heat dissipation module with a heat pipe 16 accommodated therein, further improving the heat dissipation.

Abstract

A heat dissipation module includes a fan and a heat sink. The shaft of the fan, made from materials with high thermal conductivity or being a heat pipe, has a first end and an opposite second end. ~~[[,]]~~ with the The first end of the shaft penetrating penetrates a fan hub and connects ~~connecting~~ to a heating element. The heat sink is connected to the second end of the shaft.